

RV1S2752Q

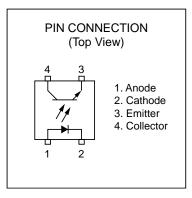
AUTOMOTIVE HIGH ISOLATION VOLTAGE, 4-PIN SOP (SO4) PHOTOCOUPLER

DESCRIPTION

The RV1S2752Q is an optically coupled isolator containing an AlGaAs LED and an NPN silicon phototransistor. The package is a small outline package (SOP) type and has a shield effect to cut the ambient light. The RV1S2752Q features high isolation voltage and wide operating temperature (-40 to +135 °C), which is suitable for automotive application.

FEATURES

- Operating ambient temperature ($T_A = -40$ to +135 °C)
- High isolation voltage (BV = 3 750 Vr.m.s.)
- Small package (SO4)
- Pb-free product
- AEC-Q100 (Grade 1: $T_A = -40$ to +125 °C) compliant
- Safety standard
- • UL : UL1577, Double protection



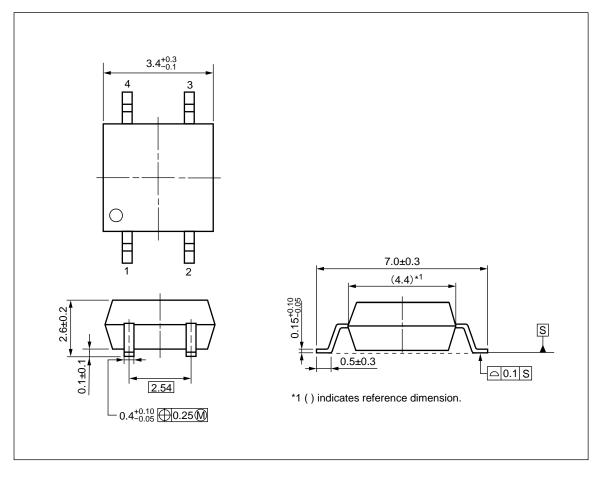
APPLICATIONS

Consumer vehicles

R08DS0189EJ0200 Rev.2.00 Mar 09, 2023



PACKAGE DIMENSIONS (UNIT: mm)



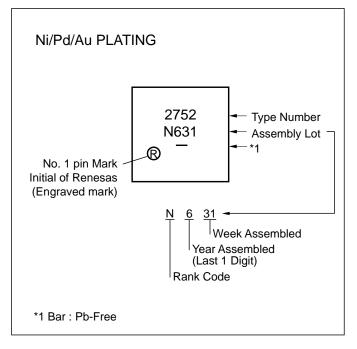
Weight: 0.08 g (TYP.)

PHOTOCOUPLER CONSTRUCTION

Parameter	MIN.	
Air Distance	4.2 mm	
Creepage Distance	4.2 mm	
Isolation Distance	0.2 mm	



MARKING EXAMPLE



ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number ^{*1}
RV1S2752QKCSP- 1000N	RV1S2752QKCSP- 1000N#SC0	Pb-Free (Ni/Pd/Au)	Embossed Tape 20 pcs	Standard Products (UL Approved)	RV1S2752Q
	RV1S2752QKCSP- 1000N#KC0		Embossed Tape 2 500 pcs/reel		

. Notes: *1. For the application of the safety standard, the following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current ^{*1}	lf	25	mA
	Reverse Voltage	V _R	5	V
	Power Dissipation*2	P _D	50	mW
	Peak Forward Current ^{*3}	IFP	1	А
Transistor	Collector to Emitter Voltage	Vceo	40	V
	Emitter to Collector Voltage	Veco	6	V
	Collector Current	lc	50	mA
	Power Dissipation ^{*4}	Pc	150	mW
Isolation V	oltage ^{*5}	BV	3 750	Vr.m.s.
Operating Ambient Temperature		TA	-40 to +135	°C
Storage Temperature		Tstg	–55 to +150	°C

*1 Reduced at a rate of 0.5 mA/°C above $T_A = 115$ °C.

*2 Reduced at a rate of 1.0 mW/°C above $T_A = 115$ °C.

*3 PW = 100 μ s, Duty Cycle = 1 %

*4 Reduced at a rate of 1.2 mW/°C above $T_A = 25$ °C.

*5 AC voltage for 1 minute at $T_A = 25$ °C, RH = 60 % between input and output. Pins 1-2 shorted together, 3-4 shorted together.

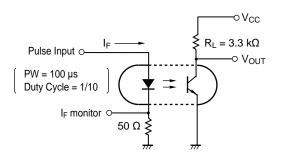


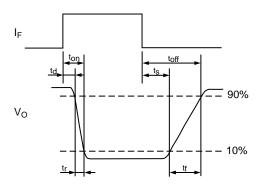
ELECTRICAL CHARACTERISTICS (T_A = - 40 to + 135 °C, unless otherwise specified)

	Parameter	Symbol	Conditions	MIN.	TYP. ^{*1}	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA	1.18	1.65	1.98	V
	Reverse Current	lr	V _R = 3 V			100	μA
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz, T _A = 25 °C		30		pF
Transistor	Collector to Emitter Dark Current	Iceo	V _{CE} = 5.5 V			65	μΑ
Coupled	Current Transfer Ratio	CTR	IF = 2 mA, VCE = 5 V, TA = 25 °C	200	500	850	%
	(_C / _F)		IF = 2 mA, VCE = 5 V	65			
	Collector Saturation Voltage	VCE (sat)	l⊧ = 2 mA, lc = 1.5 mA			0.3	V
	Isolation Resistance	R ⊦o	$V_{I-O} = 500 V_{DC}, RH = 40 \sim 60 \%,$	10 ¹⁰			Ω
	Isolation Capacitance	CI-0	V = 0 V, f = 1 MHz		0.4	1.0	pF
	Turn-on Time *2	ton	$V_{CC} = 5 \text{ V}, \text{ I}_{F} = 2 \text{ mA}, \text{ R}_{L} = 3.3 \text{ k}\Omega$		10	100	μs
	Turn-off Time *2	toff	C∟ = 15 pF		150	300	
	Rise Time *2	tr			8		
	Fall Time *2	tr			120		
	Storage Time *2	t₅				200	

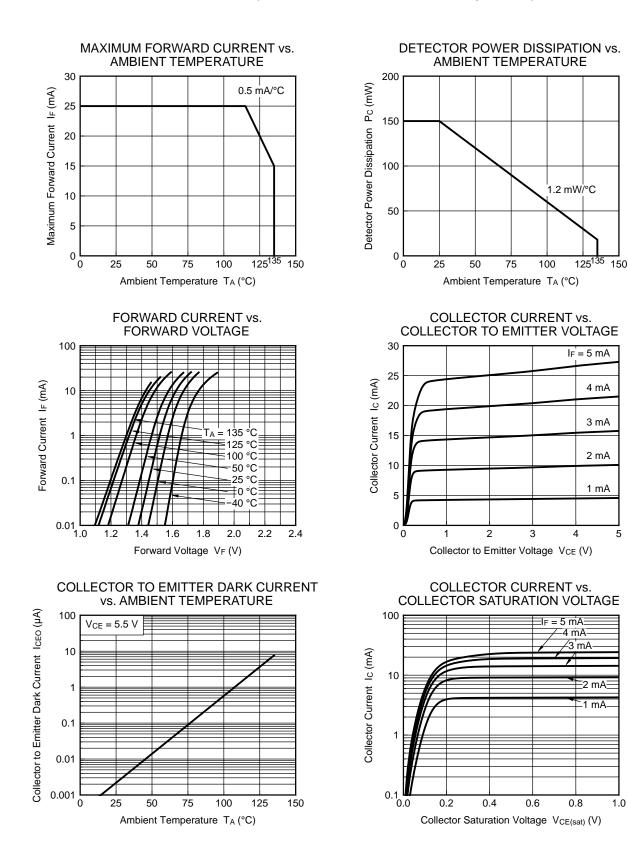
*1 Typical values at $T_A = 25 \ ^{\circ}C$

*2 Test circuit for switching time

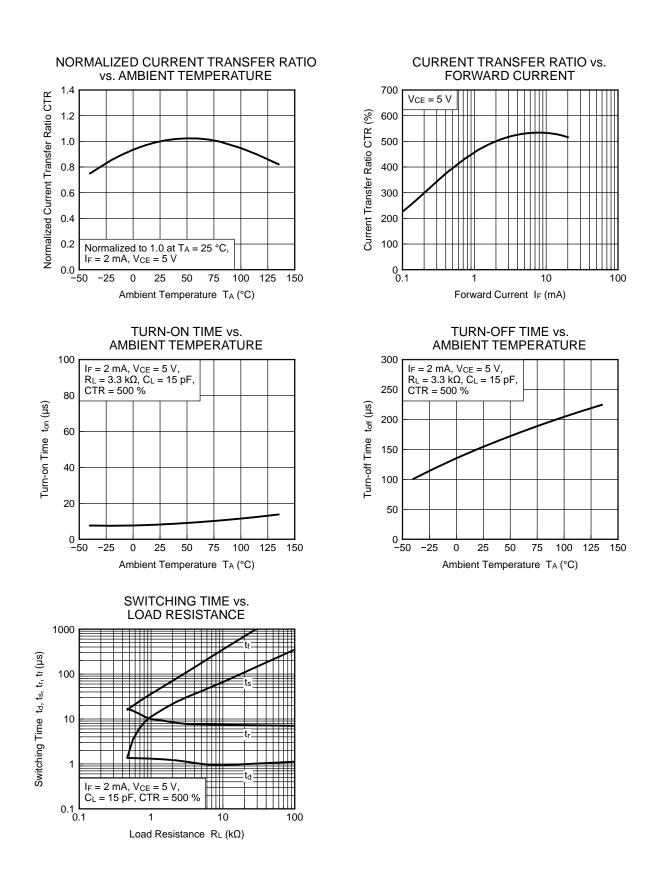




TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise specified)

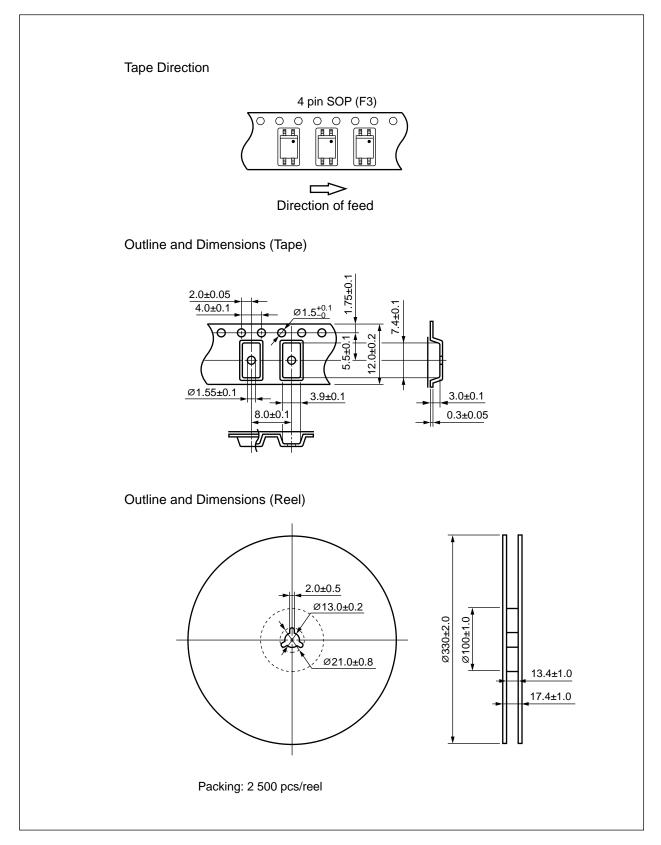


Remark The graphs indicate nominal characteristics.

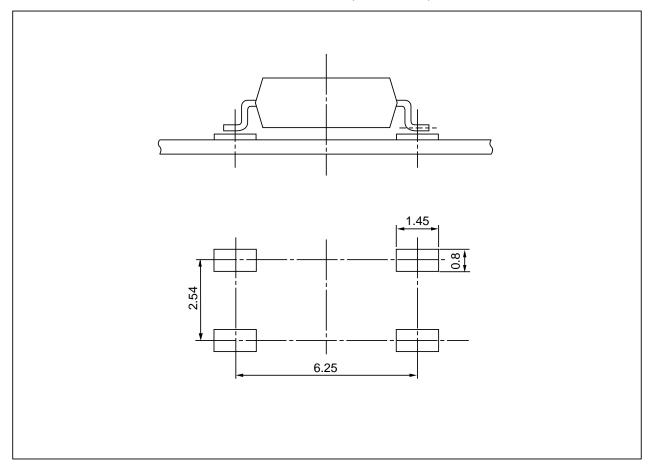


Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (UNIT: mm)



RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



Remark All dimensions in this figure must be evaluated before use.



NOTES ON HANDLING

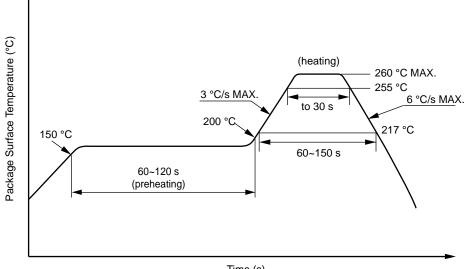
- 1. Recommended soldering conditions
 - (1) Infrared reflow soldering
 - Peak reflow temperature
 - Time of peak reflow temperature -5 °C (255 °C)
 - Time of temperature higher than 217 °C
 - Time to preheat temperature from 150 to 200 °C
 - Number of reflows
 - Flux

260 °C or below (package surface temperature)

- 30 s or less
- 60 ~ 150 s
- 60 ~ 120 s 3

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)



(2) Wave soldering

- Temperature 260 °C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120 °C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Rosin flux containing small amount of chlorine (The flux with a maximum Flux chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

- Peak temperature (lead part temperature) 350 °C or below
 - Time (per one side) 3 s or less
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended.)
 - Place 1.5 to 2.0 mm or more away from the root of the lead
- (4) Cautions
 - Flux cleaning Avoid cleaning with Freon- or halogen-based (chlorinated etc.) solvents.
 - Fixing/Coating Do not use fixing agents or coatings containing halogen-based substances.

USAGE CAUTIONS

- 1. Be aware that when voltage is applied suddenly between the photocoupler's input and output or between the collector and the emitter at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.
- 2. Protect against static electricity when handling.
- 3. Avoid storage at a high temperature and high humidity.

Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	 Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
	2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	• Do not burn, destroy, cut, crush, or chemically dissolve the product.
	• Do not lick the product or in any way allow it to enter the mouth.

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